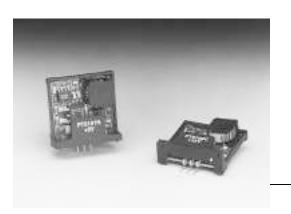
### PT5100 Series

1-A Positive Step-down Integrated Switching Regulator

SLTS028B

#### (Revised 11/8/2001)



#### **Features**

- 90%+ Efficiency
  - Internal Short-Circuit Protection
- Pin-Compatible with 3-Terminal Linear Regulators
- Laser-Trimmed Output Voltage
- Over-Temperature Protection
- Small Footprint
- Wide Input Range
- 5-Pin Mount Option (Suffixes L & M)

#### **Description**

The PT5100 modules are a series of economical, easy-to-use 1-A positive step-down, Integrated Switching Regulators (ISRs). These ISRs are compatible with most TO-220 style linear regulators, and when employed as a linear replacement, provide significant benefits in both efficiency and power dissipation. They are recommended for use in a wide variety of on-board power regulation applications. These include computer, data storage, industrial controls, and battery powered equipment. Modules are laser-trimmed for optimal output voltage accuracy, and exhibit excellent line and load regulation. The PT5100 also features output current limiting and thermal shutdown protection.

#### **Standard Application**

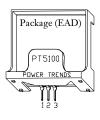


PT5101□	=	+5.0 Volts
PT5102□	=	+12.0 Volts
PT5103□	=	+3.3 Volts
PT5105□	=	+6.5 Volts
PT5107□	=	+15.0 Volts
PT5109□	=	+5.6 Volts
PT5110□	=	+9.0 Volts
PT5111□	=	+10.0 Volts
PT5112	=	+8.0 Volts

#### PT Series Suffix (PT1234x)

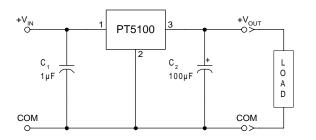
Order Suffix	Package Code
Ν	(EAD)
Α	(EAA)
C	(EAC)
Μ	(EAM)
L	(EAL)
	Suffix N A C

(Reference the applicable package code drawing for the dimensions and PC board layout)



#### **Pin-Out Information**

Pin	Function
1	V <sub>in</sub>
2	GND
3	$V_{out}$



 $C_1$  = Optional 1µF ceramic capacitor  $C_2$  = Required 100µF electrolytic



**1-A Positive Step-down Integrated Switching Regulator** 

				PT5100 SERIES				
Characteristic	Symbol	Conditions	Min	Тур	Max	Units		
Output Current	Io	Over V <sub>in</sub> range		0.1 (1)	_	1.0	А	
Input Voltage Range	V <sub>in</sub>	Over I <sub>o</sub> Range	V <sub>o</sub> =3.3V V <sub>o</sub> =5.0V V <sub>o</sub> >5.0V	9 9 V <sub>o</sub> +4		26 38 38	VDC	
Set Point Voltage Tolerance	Votol			_	±1	±2	%Vo	
Temperature Variation	Reg <sub>temp</sub>	$0^{\circ} \leq T_a \leq +60^{\circ}C$ , $I_o = I_omin$		_	±0.5	_	%Vo	
Line Regulation	Regline	Over V <sub>in</sub> range		_	±5	±10	mV	
Load Regulation	Regload	Over I <sub>o</sub> range		_	±5	±10	mV	
Total Output Voltage Variation	$\Delta V_{o}$ tot	Includes set-point, line, load, $0^{\circ} \le T_a \le +60^{\circ}C$		_	±1.5	±3	%Vo	
Efficiency	η		$V_{o} = 15V \\ V_{o} = 12V \\ V_{o} = 10V \\ V_{o} = 5.0V \\ V_{o} = 3.3V$	 	95 94 92 90 82	 	%	
Vo Ripple (pk-pk)	Vr	20MHz bandwidth		_	2	_	%Vo	
Transient Response	t <sub>tr</sub>	1A/µs load step, 50% to 100% Iomax		_	100	200	μs	
	$\Delta V_{tr}$	V <sub>o</sub> over/undershoot		_	±5.0	_	%Vo	
Current Limit	Ilim	$\Delta V_o = -1\%$		1.2	2.6	_	Α	
Switching Frequency	$f_{s}$	Over V <sub>in</sub> range	V <sub>o</sub> ≥5.0V V <sub>o</sub> ≤3.3V	500 575	650 725	800 875	kHz	
External Output Capacitance	Cout			100	_	_	μF	
Operating Temperature Range	Ta	Over Vin range		-40 (2)	_	+85 (3)	°C	
Thermal Resistance	$\theta_{ja}$	Free-air convection (40-60LFM)	$\begin{array}{l} V_{o} = 3.3 V \\ V_{o} = 5.0 V \\ V_{o} \ge 12 V \end{array}$		45 50 60		°C/W	
Storage Temperature	Ts	—		-40	_	+125	°C	
Reliability	MTBF	Per Bellcore TR-332 50% stress, T <sub>a</sub> =40°C, ground benign		11.3	—	_	106 H	
Mechanical Shock	_	Per Mil-Std-883D, method 2002.3, 1mS, half-sine, mounted to a fixture		—	500	—	G's	
Mechanical Vibration	—	Per Mil-Std-883D, Method 2007.2 20-2000Hz, soldered in PC board		—	5 (4)	—	G's	
Weight		Suffixes N, A, & C Suffixes L & M		_	4.5 6.5		grams	
Flammability	_	Materials meet UL 94V-0						

**Specifications** (Unless otherwise stated,  $T_a = 25^{\circ}$ C,  $V_{in} = V_{in}min$ ,  $C_{out} = 100\mu$ F, and  $I_o = I_omax$ )

Notes: (1) The ISR will operate at no load with reduced specifications.
(2) For operation below 0°C, use a tantalum type capacitor for C<sub>2</sub>.
(3) See Thermal Derating curves.
(4) The tab pins on the 5-pin mount package types (suffixes L & M) must be soldered. For more information see the applicable package outline drawing.



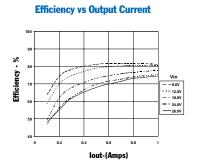
### Typical Characteristics

1-A Positive Step-down Integrated Switching Regulator

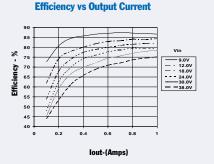


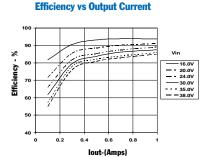
#### **PT5101, 5.0 VDC** (See Note A)

**PT5102, 12.0 VDC** (See Note A)

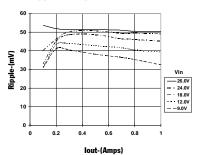


**Ripple vs Output Current** 

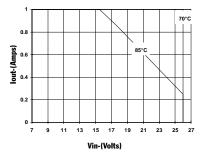




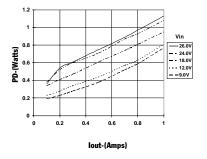
### **Ripple vs Output Current**

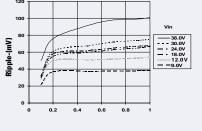


Thermal Derating (T<sub>a</sub>) (See Note B)



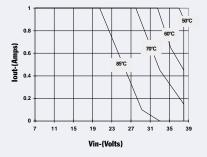
#### **Power Dissipation vs Output Current**



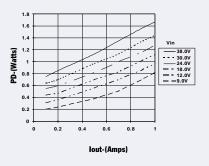


lout-(Amps)

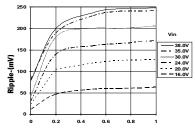




#### Power Dissipation vs Output Current

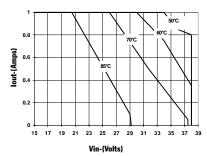


**Ripple vs Output Current** 

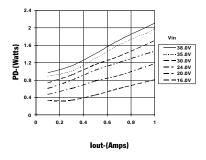


lout-(Amps)





#### **Power Dissipation vs Output Current**



**Note A:** Characteristic data has been developed from actual products tested at 25°C. This data is considered typical data for the Converter. **Note B:** Thermal derating graphs are developed in free-air convection cooling, which corresponds to approximately 40–60LFM of airflow.





www.ti.com

#### **PACKAGING INFORMATION**

#### Status (1) Package Type **Orderable Device** Package Pins Package Qty Eco Plan<sup>(2)</sup> l ead/ Samples MSL Peak Temp (3) Drawing Ball Finish (Requires Login) PT5101A NRND SIP MODULE EAA 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available 3 PT5101C NRND SIP MODULE EAC 3 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available 200 PT5101CT NRND SIP MODULE EAC 3 TBD Call TI Level-1-215C-UNLIM Samples Not Available NRND SIP MODULE Pb-Free (RoHS) PT5101G EAG 3 16 Call TI N / A for Pkg Type Samples Not Available PT5101H NRND SIP MODULE EAH 3 16 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5101J NRND SIP MODULE EAJ 16 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM 3 Samples Not Available PT5101L NRND SIP MODULE EAL 3 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available PT5101M NRND SIP MODULE EAM 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available NRND SIP MODULE N / A for Pkg Type PT5101N EAD 35 Pb-Free (RoHS) Call TI 3 Samples Not Available PT5101S NRND SIP MODULE EAF 3 16 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5101U NRND SIP MODULE EAU 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5102A NRND SIP MODULE EAA 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5102C NRND SIP MODULE 3 35 Call TI Level-1-215C-UNLIM EAC Pb-Free (RoHS) Samples Not Available PT5102CT NRND SIP MODULE 200 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available EAC 3 N / A for Pkg Type PT5102H NRND SIP MODULE EAH 3 16 Pb-Free (RoHS) Call TI Samples Not Available NRND PT5102M SIP MODULE EAM 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5102N NRND SIP MODULE 35 Call TI N / A for Pkg Type EAD 3 Pb-Free (RoHS) Samples Not Available PT5103A NRND SIP MODULE EAA 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5103C NRND SIP MODULE EAC 3 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available PT5103L NRND SIP MODULE EAL 3 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available PT5103M NRND SIP MODULE EAM 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available N / A for Pkg Type PT5103N NRND SIP MODULE EAD 3 35 Pb-Free (RoHS) Call TI Samples Not Available PT5105A NRND SIP MODULE EAA 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available NRND PT5105C SIP MODULE EAC 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM 3 Samples Not Available PT5105N NRND SIP MODULE EAD 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5107A NRND SIP MODULE EAA 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available PT5107C NRND SIP MODULE EAC 3 35 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available PT5107J NRND SIP MODULE EAJ 3 16 Pb-Free (RoHS) Call TI Level-1-215C-UNLIM Samples Not Available PT5107M NRND SIP MODULE 35 Pb-Free (RoHS) Call TI N / A for Pkg Type EAM 3 Samples Not Available PT5107N NRND SIP MODULE EAD 3 35 Pb-Free (RoHS) Call TI N / A for Pkg Type Samples Not Available

PACKAGE OPTION ADDENDUM

28-Aug-2010

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#### PACKAGE OPTION ADDENDUM

28-Aug-2010

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
PT5109A	NRND	SIP MODULE	EAA	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Available
PT5109C	NRND	SIP MODULE	EAC	3	35	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	Samples Not Available
PT5109M	NRND	SIP MODULE	EAM	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Available
PT5109N	NRND	SIP MODULE	EAD	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availabl
PT5110A	NRND	SIP MODULE	EAA	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availabl
PT5110C	NRND	SIP MODULE	EAC	3	35	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	Samples Not Availab
PT5110N	NRND	SIP MODULE	EAD	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availabl
PT5111A	NRND	SIP MODULE	EAA	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availabl
PT5111M	NRND	SIP MODULE	EAM	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availab
PT5111N	NRND	SIP MODULE	EAD	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availab
PT5112A	NRND	SIP MODULE	EAA	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availab
PT5112C	NRND	SIP MODULE	EAC	3	35	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	Samples Not Availab
PT5112N	NRND	SIP MODULE	EAD	3	35	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	Samples Not Availab

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" man semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS): Ti's terms"Lead-Free" or "Pb-Free" man semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above. Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### PACKAGE OPTION ADDENDUM

28-Aug-2010

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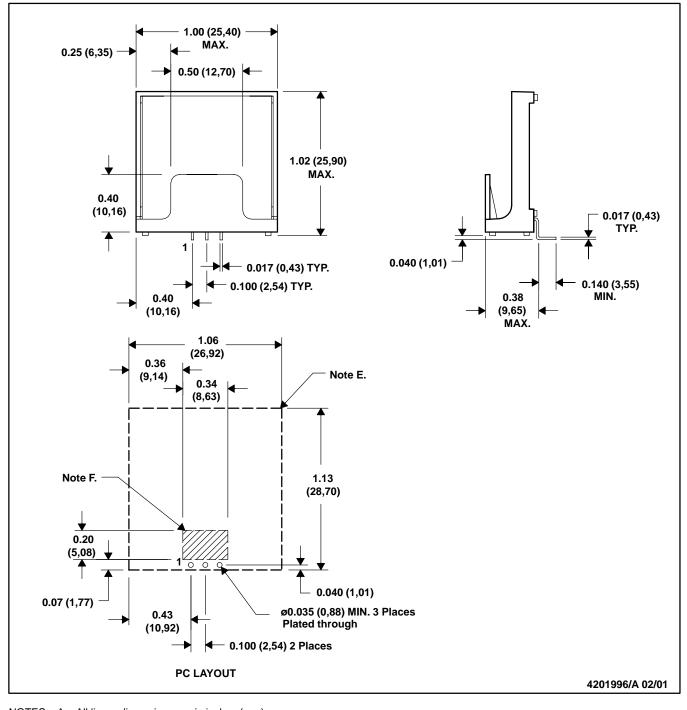
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MPSI005 - MARCH 2001

EAA (R-PSIP-T3)

#### PLASTIC SINGLE-IN-LINE MODULE



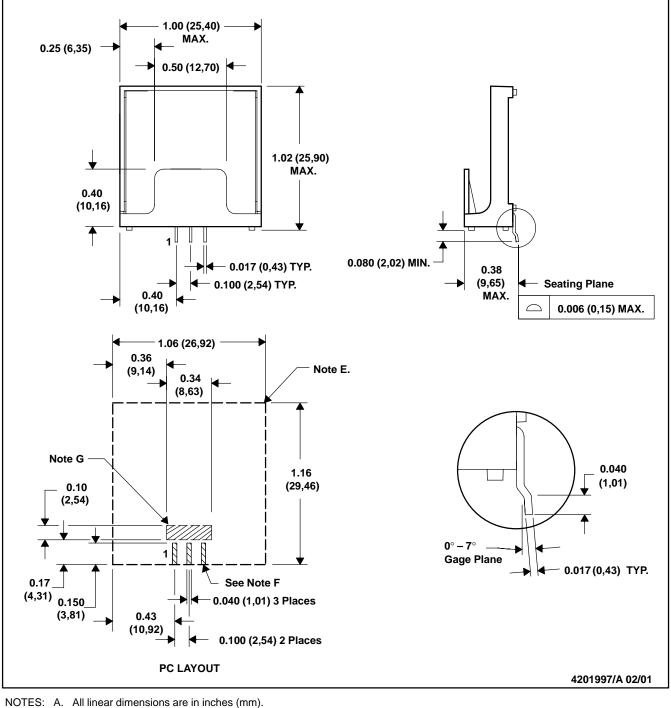
NOTES: A. All linear dimensions are in inches (mm).

- B. This drawing is subject to change without notice.
- C. 2–place decimals are  $\pm$  0.030 (  $\pm$  0,76 mm).
- D. 3–place decimals are  $\pm$  0.010 (  $\pm$  0,25 mm).
- E. Recommended mechanical keep-out area.
- F. No copper, power or signal traces in this area.

MPSI006 - MARCH 2001

EAC (R-PSIP-G3)

#### PLASTIC SINGLE-IN-LINE MODULE



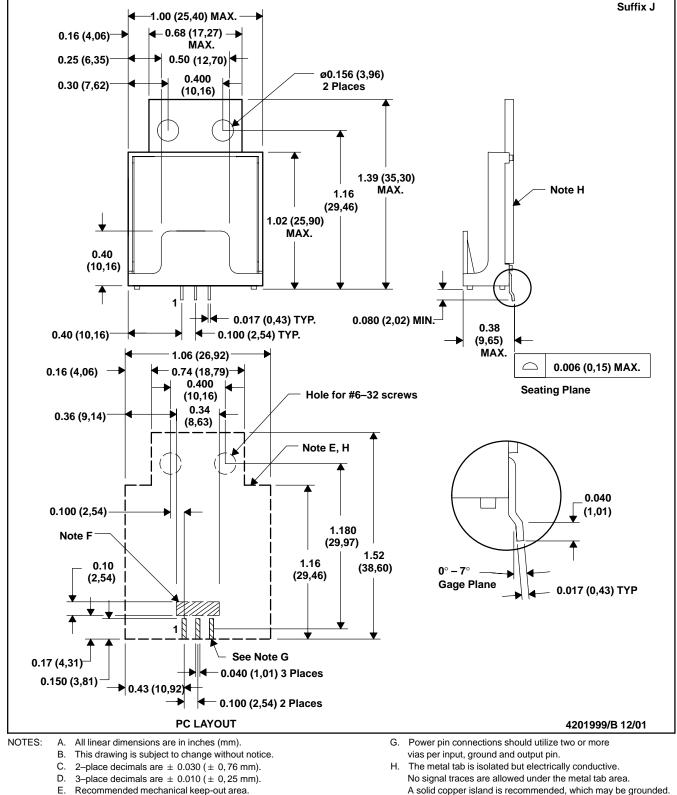
JIES. A. All linear dimensions are in inches (mm).

- B. This drawing is subject to change without notice. C. 2-place decimals are  $\pm$  0.030 ( $\pm$  0,76 mm).
- D. 3-place decimals are  $\pm$  0.010 ( $\pm$  0, 75 mm).
- E. Recommended mechanical keep-out area.
- F. Power pin connections should utilize two or more vias per input, ground and output pin.
- G. No copper, power or signal traces in this area.

MPSI007A - MARCH 2001 0 REVISED JANUARY 2002

#### PLASTIC SINGLE-IN-LINE MODULE

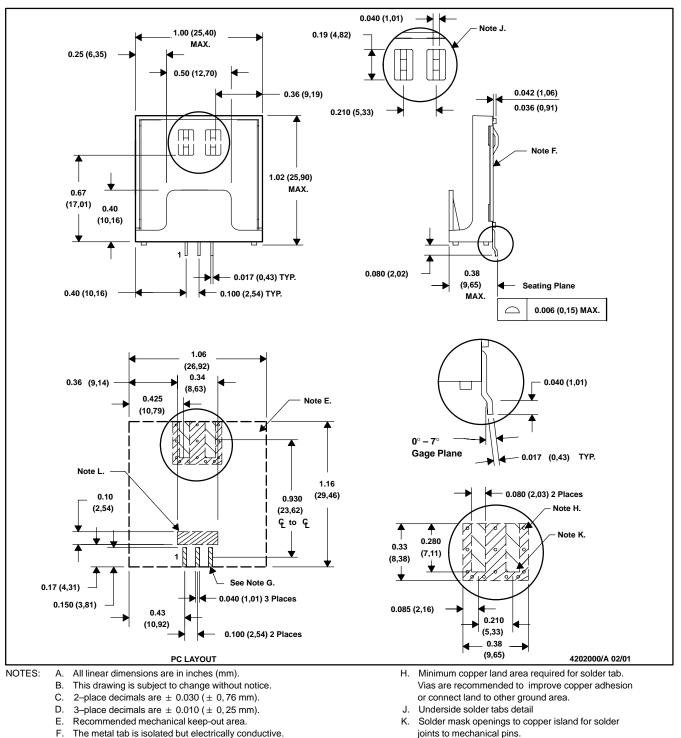




A solid copper island is recommended, which may be grounded.



MPSI008 - MARCH 2001



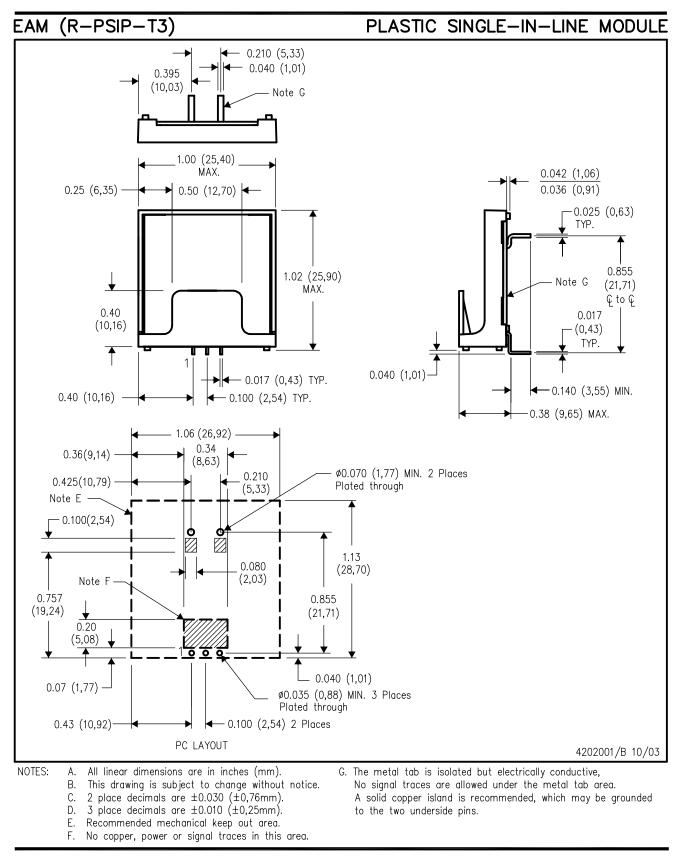
#### EAL (R-PSIP-G3)

PLASTIC SINGLE-IN-LINE MODULE

No signal traces are allowed under the metal tab area. A solid copper island is recommended, which may be grounded.

G. Power pin connections should utilize two or more vias per input, ground and output pin.

L. No copper, power or signal traces in this area.

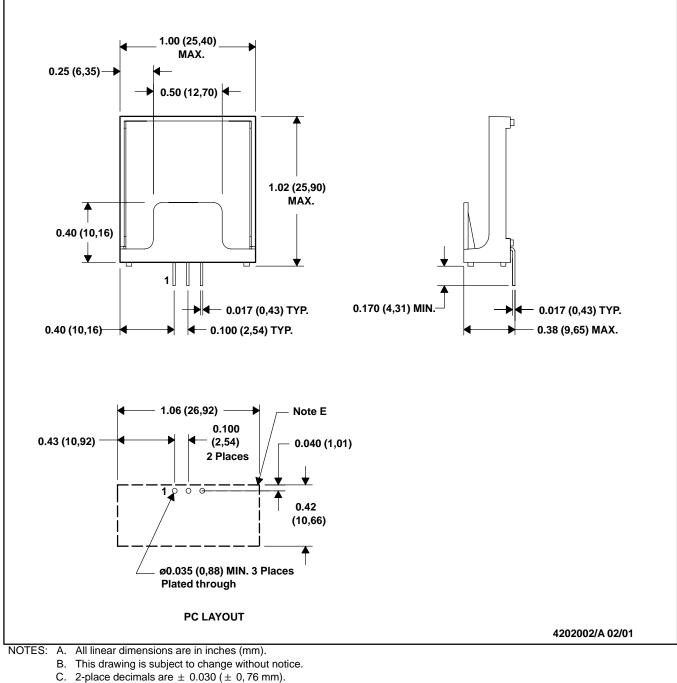




MPSI010 - MARCH 2001

EAD (R-PSIP-T3)

#### PLASTIC SINGLE-IN-LINE MODULE



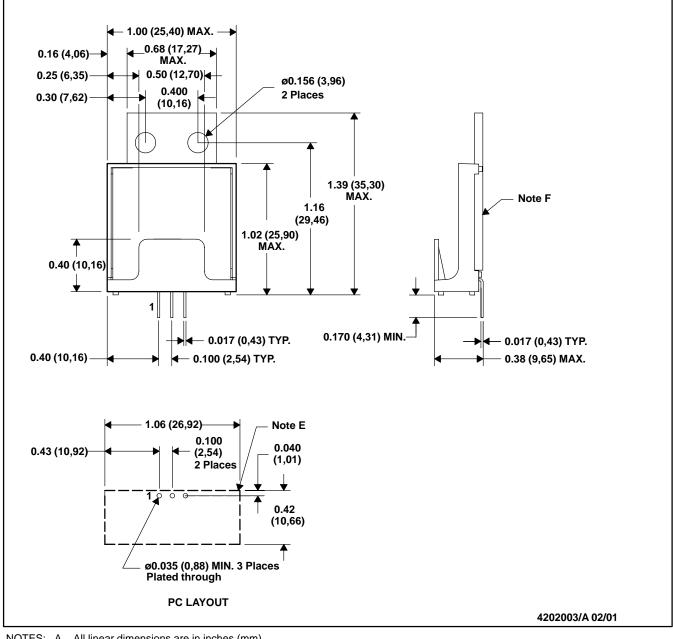
- D. 3-place decimals are  $\pm$  0.010 ( $\pm$  0, 25 mm). E. Recommended mechanical keep-out area.

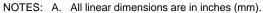


MPSI011 - MARCH 2001

EAF (R-PSIP-T3)

#### PLASTIC SINGLE-IN-LINE MODULE





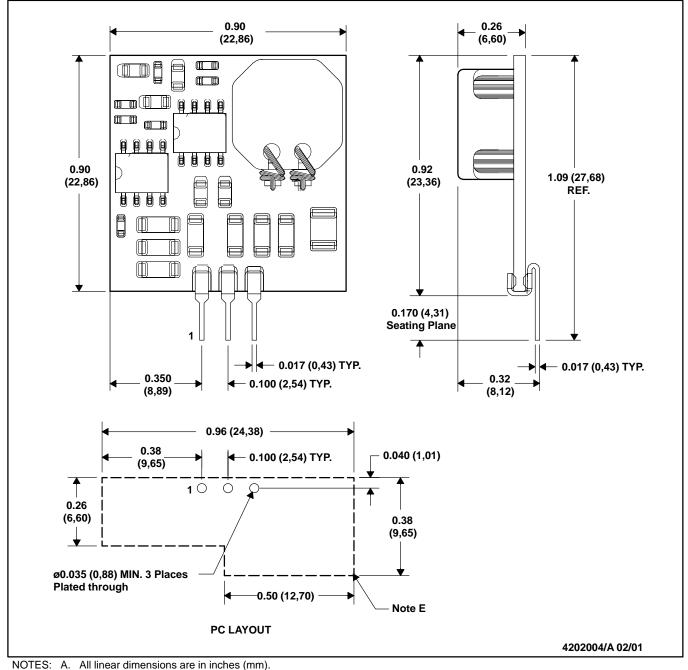
- B. This drawing is subject to change without notice.
- C. 2-place decimals are  $\pm$  0.030 ( $\pm$  0,76 mm).
- D. 3-place decimals are  $\pm$  0.010 ( $\pm$  0,25 mm).
- E. Recommended mechanical keep-out area.
- F. The metal tab is isolated but electrically conductive, it can be grounded.



MPSI012 - MARCH 2001



PLASTIC SINGLE-IN-LINE MODULE

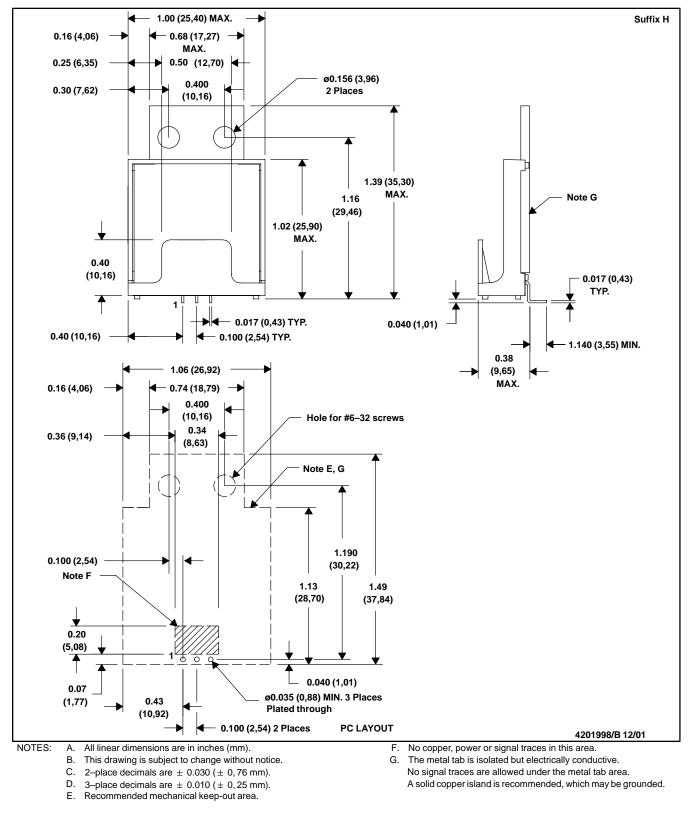


- B. This drawing is subject to change without notice.
- C. 2-place decimals are  $\pm$  0.030 ( $\pm$  0,76 mm).
- D. 3-place decimals are  $\pm$  0.010 ( $\pm$  0, 25 mm).
- E. Recommended mechanical keep-out area.



MPSI023A - MARCH 2001 - REVISED JANUARY 2002

#### PLASTIC SINGLE-IN-LINE MODULE





EAH (R-PSIP-T3)

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